

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

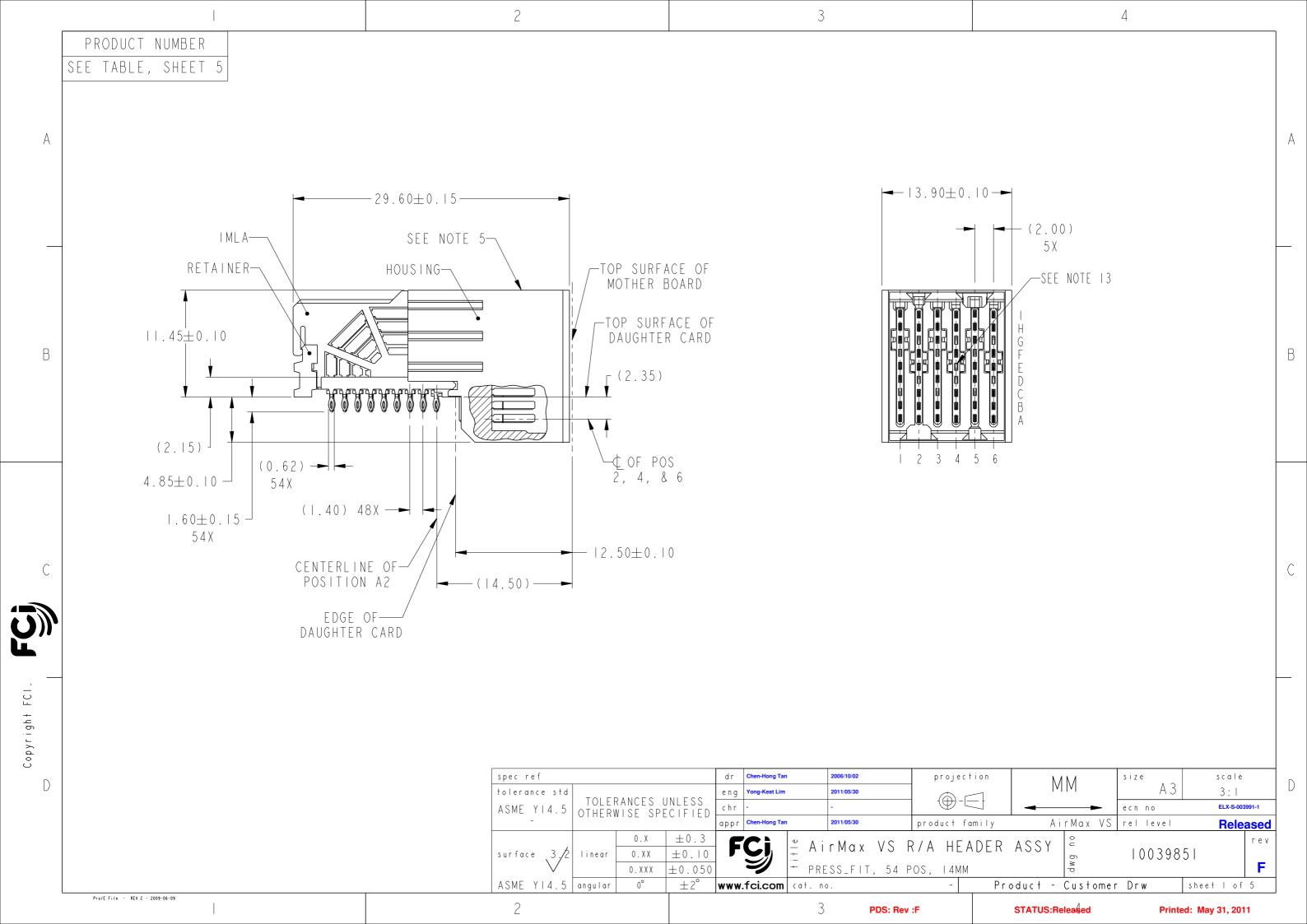
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

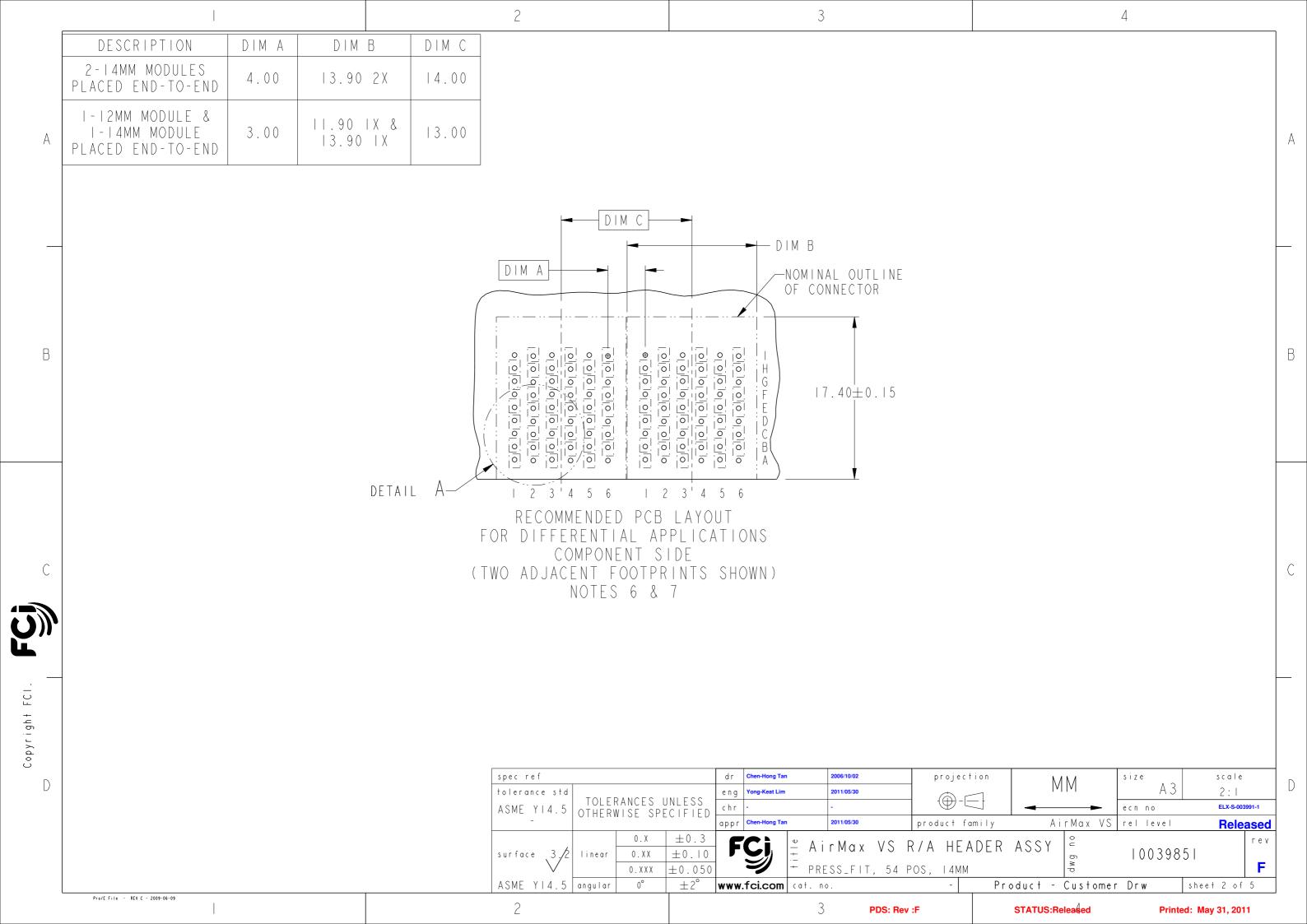
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

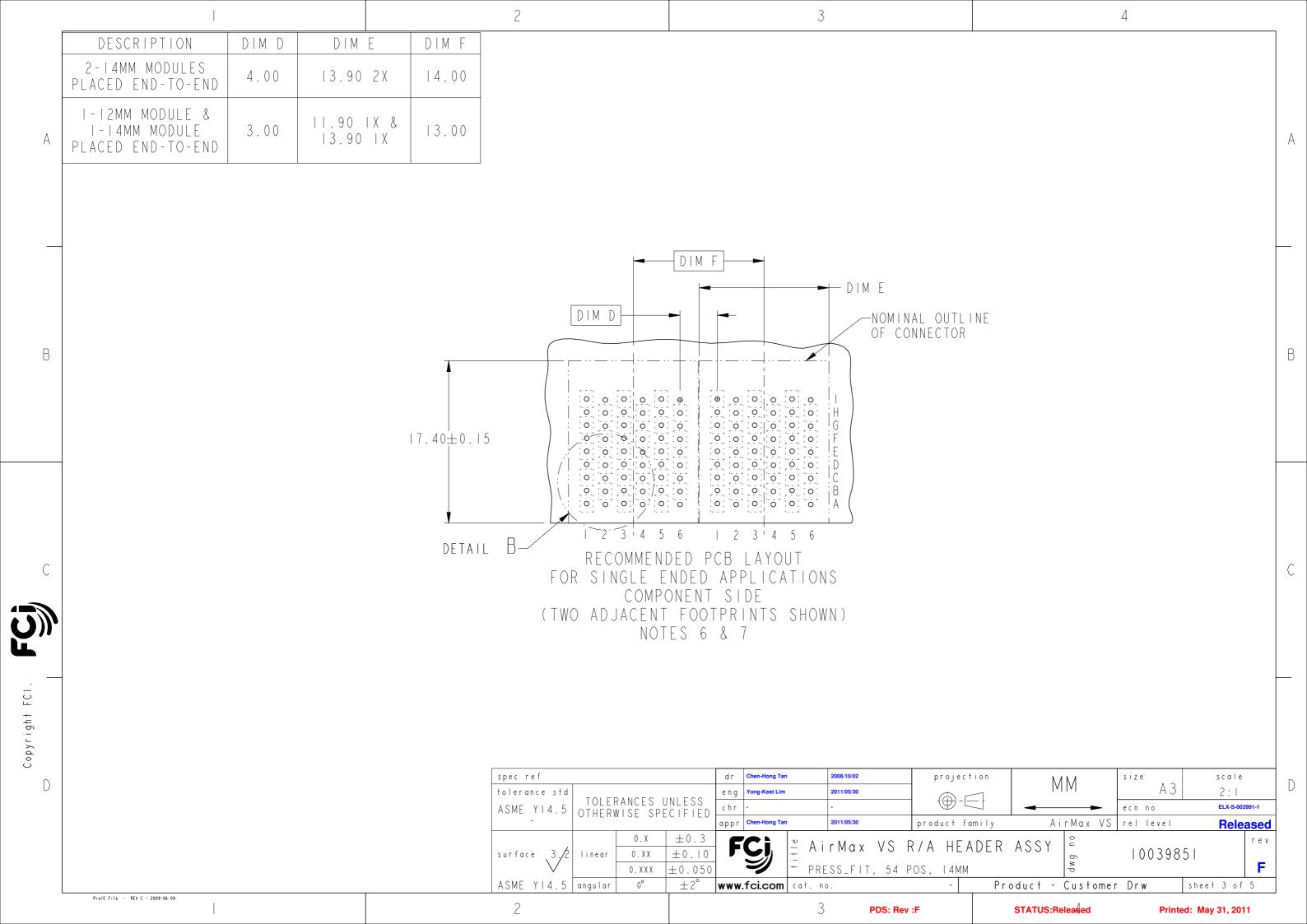


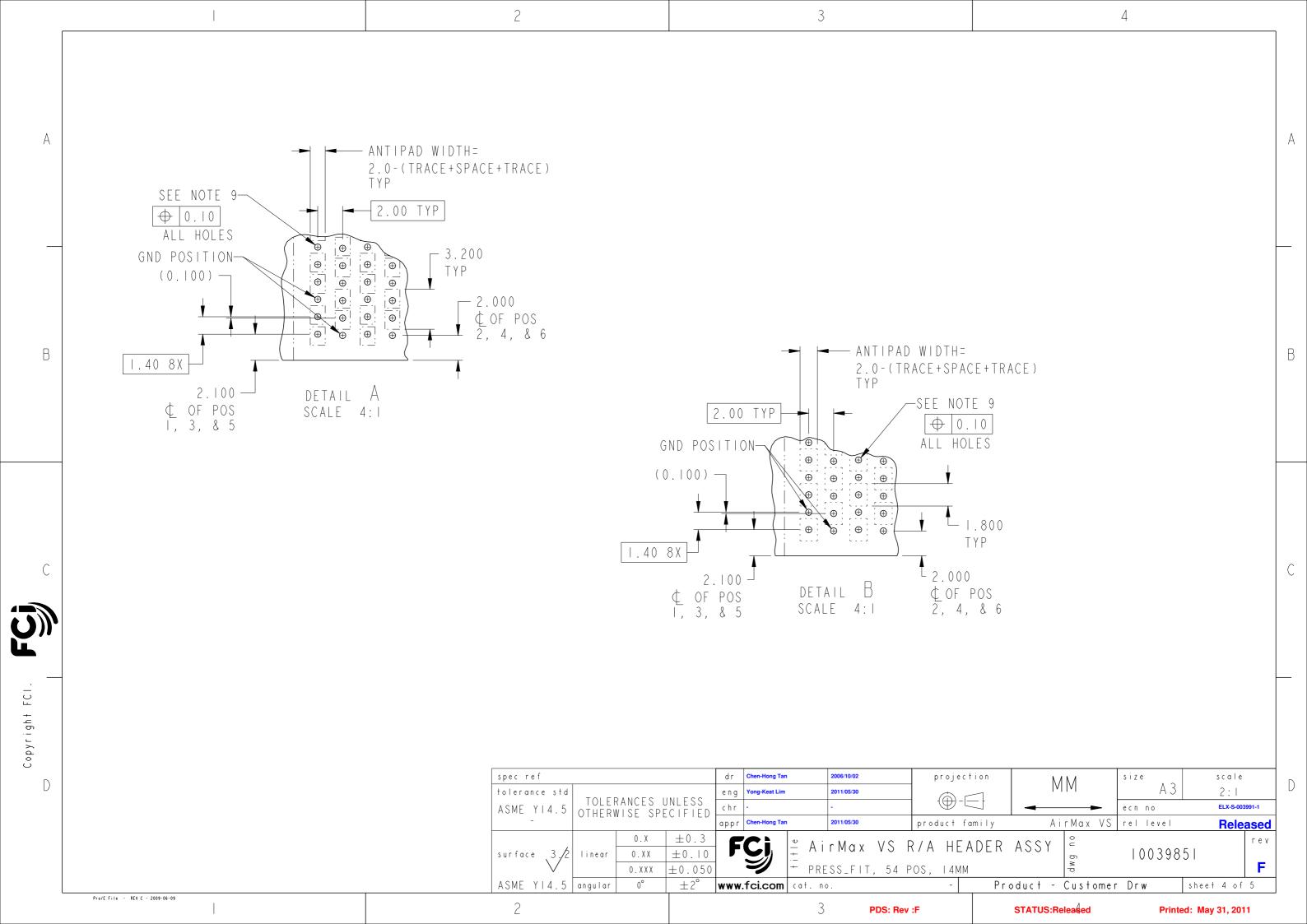












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PART NUMBER	PRESS-FIT TAIL PLATING TYPE	SHORT DETECT CONTACT			
10039851-101	TIN/LEAD ALLOY OVER NICKEL	NO			
10039851-101LF	TIN OVER NICKEL (LEAD FREE)	NO			
10039851-111	TIN/LEAD ALLOY OVER NICKEL	YES			
10039851-111LF	TIN OVER NICKEL (LEAD FREE)	(SEE NOTE 13)			

NOTES:

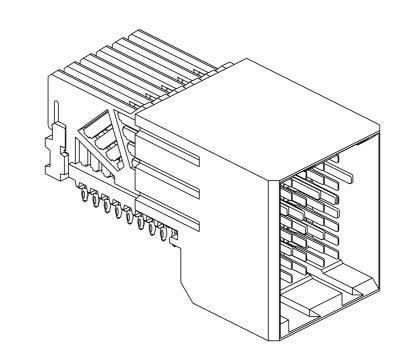
CONNECTOR MATERIALS:
HOUSING & RETAINER: HIGH TEMP THERMOPLASTIC, NATURAL, UL94V-0
IMLA PLASTIC: HIGH TEMP THERMOPLASTIC, BLACK, UL94V-0
CONTACT: COPPER ALLOY

2. CONTACT PLATING:

SEPARABLE INTERFACE:
PERFORMANCE-BASED PLATING, QUALIFIED TO MEET THE
REQUIREMENTS OF FCI PRODUCT SPECIFICATION GS-12-239
INCLUDING TELCORDIA GR-1217-CORE (NOVEMBER 1995)
CENTRAL OFFICE TEST SEQUENCE

PRESS-FIT TAILS: SEE TABLE

- 3. PRODUCT SPECIFICATION: GS-12-239
- 4. APPLICATION SPECIFICATION: GS-20-035
- (5.) PRODUCT MARKING, (PART NUMBER & LOT CODE), ON THIS SURFACE
- 6. REFER TO CUSTOMER DRAWING 10035911 FOR INFORMATION REGARDING PCB LAYOUT OF POWER AND GUIDE MODULES RELATIVE TO SIGNAL MODULES
- 7. POSITIONS F OF ODD NUMBERED COLUMNS AND POSITIONS G
 OF EVEN NUMBERED COLUMNS CORRESPOND TO EARLY MATE HEADER PINS
- 8. THERE IS NO GROUND BUSSING WITHIN THE CONNECTOR SYSTEM
- (9.) REFER TO CUSTOMER DRAWING 10045979 FOR INFORMATION ON PCB HOLE DIAMETERS AND PLATING OPTIONS.



- 10. LEAD FREE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
- II. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 40 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.
- 12. PACKAGING MEETS GS-14-920 LEAD FREE LABELING SPECIFICATION.
- (13) MATING PIN E4 HAS 0.5mm LESS NOMINAL WIPE THAN THE SHORTEST SIGNAL PIN.

	spec ref				dr	γ Chen-Hong Tan		2006/10/02		projection			ММ	size	sca	l e
	tolerance std	E YI4.5 OTHERWISE SPECIFIED		eng	Yong-Keat Lim		2011/05/30						A 3	3:	1	
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			0.XXX	±0.050			+ PRE	ESS_FIT,	54 P	OS, 14	ММ		» p			F
	ASME YI4.5	angular	0°	±2°	www.	fci.com	cat. no	٥.		-	Pi	roduct	- Customer	Drw	sheet 5	of 5

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